MPBW50N65EC

650V-50A Trench and Field Stop IGBT

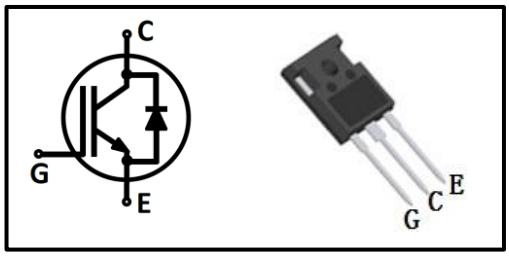
Features

- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low V_{CEsat}, fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Applications

- Welding Machine
- UPS
- Home Fitness

Type	Marking	Package Code
MPBW50N65EC	MP50N65EC	TO-247-3



Maximum Rated Values [1]

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CE}	650	V
DC collector current[2]			A
T_C=25℃	I_C	80	
T_C=100℃		50	
Pulsed collector current[3]	I_{Cpuls}	200	
Diode forward current[2]			
T_C=25℃	I_F	40	
T_C=100℃		20	
Diode pulsed current[3]	I_{Fpuls}	200	
Gate-emitter voltage	V_{GE}	±20	V
Transient Gate-emitter voltage（t_p≤10us)		±30	
Power dissipation			W
T_C=25℃	P_{tot}	300	
T_C=100℃		150	
Operating junction temperature	T_j	-55~175	℃
Storage temperature	T_{stg}	-55~150	

1:Reference standard: JESD-022 2: limited by Tjmax 3: Tp limited by Tjmax ;

Thermal Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
IGBT thermal resistance, junction-case	R_{thJC}	-	-	0.5	K/W
Diode thermal resistance, junction-case	R_{thJCD}	-	-	0.65	
Thermal Resistance, junction-ambient	R_{thJA}	-	-	40	

Electrical Characteristics（at Tj=25℃, unless otherwise specified）

Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter breakdown voltage	$V_{(BR)CES}$	V_{GE}=0V, I_C=0.25mA	650	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	V_{GE}=15V, I_C=50A T_j=25℃	-	1.60	2.00	
		T_j=125℃	-	1.95	-	
		T_j=150℃	-	2.05	-	
Diode forward voltage	V_F	V_{GE}=0V， I_F=20A T_j=25℃	-	1.60	1.90	
		T_j=125℃	-	1.40	-	
		T_j=150℃	-	1.35	-	
G-E threshold voltage	$V_{GE(th)}$	I_C=1mA, V_{CE}=V_{GE}	4.5	5.5	6.5	
C-E leakage current	I_{CES}	V_{CE}=650V, V_{GE}=0V T_j=25℃	-	-	0.01	mA
		T_j=150℃	-	-	1.0	
G-E leakage current	I_{GES}	V_{CE}=0V, V_{GE}=20V	-	-	250	nA
Transconductance	g_{FS}	V_{CE}=20V, I_C=50A	-	21	-	S

Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	C_{iss}	V_{CE}=25V, V_{GE}=0V, f=1MHz	-	5810	-	pF
Output capacitance	C_{oss}		-	130	-	
Reverse transfer capacitance	C_{rss}		-	65	-	
Gate charge	Q_G	V_{CC}=300V, I_C=50A, V_{GE}=15V	-	230	-	nC

IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$	T_j=25℃, V_{CC}=400V, I_C=50A, V_{GE}=0/15V, R_G=10Ω, Inductive load	-	167	-	ns
Rise time	t_r		-	97	-	
Turn-off delay time	$t_{d(off)}$		-	316	-	
Fall time	t_f		-	68	-	
Turn-on energy	E_{on}		-	1.52	-	mJ
Turn-off energy	E_{off}		-	1.41	-	
Total switching energy	E_{ts}		-	2.93	-	
Turn-on delay time	$t_{d(on)}$	T_j=125℃, V_{CC}=400V, I_C=50A, V_{GE}=0/15V, R_G=10Ω, Inductive load	-	160	-	ns
Rise time	t_r		-	87	-	
Turn-off delay time	$t_{d(off)}$		-	350	-	
Fall time	t_f		-	76	-	
Turn-on energy	E_{on}		-	2.23	-	mJ
Turn-off energy	E_{off}		-	1.97	-	
Total switching energy	E_{ts}		-	4.20	-	

Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode reverse recovery time	t_{rr}	T_j=25℃, V_R=400V, I_F=20A, di_F/dt=220A/μs	-	87	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.25	-	μC
Diode peak reverse recovery current	I_{rrm}		-	6.0	-	A
Diode reverse recovery time	t_{rr}	T_j=125℃, V_R=400V, I_F=20A, di_F/dt=220A/μs		240		ns
Diode reverse recovery charge	Q_{rr}			1.10		uC
Diode peak reverse recovery current	I_{rrm}			10		A

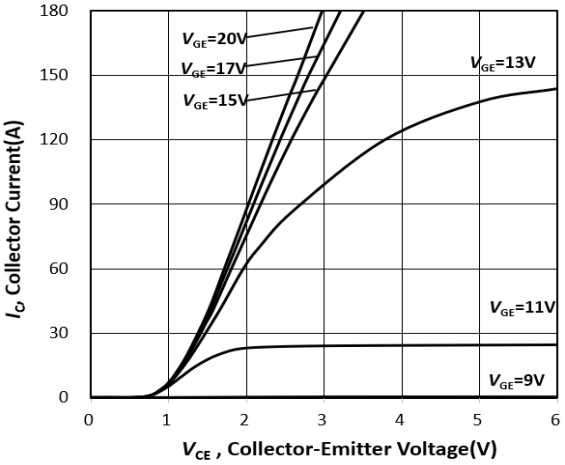


Figure1. Typical output characteristic
(T_j =25° C)

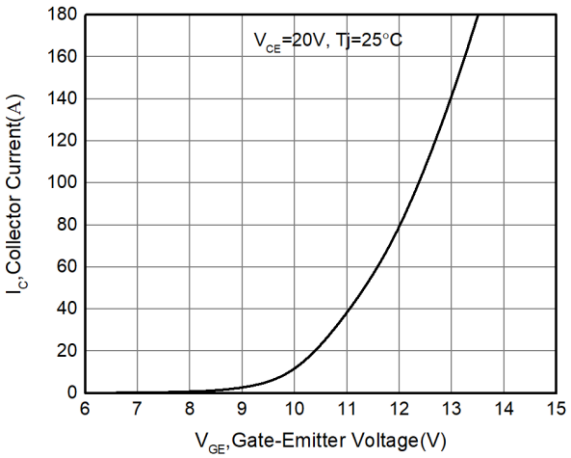


Figure 2. Typical transfer characteristic
(T_j =25° C)

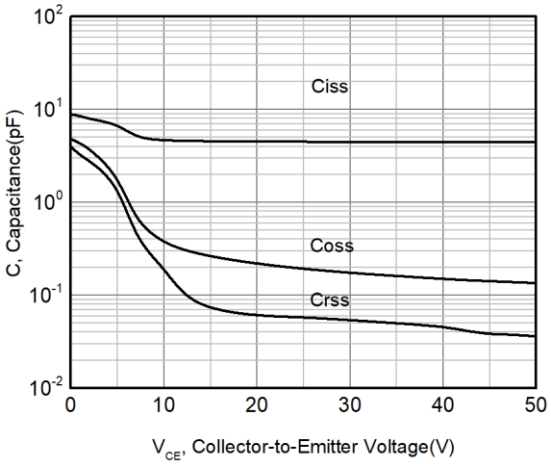


Figure 3. Capacitance characteristic
(V_{GE}=0V, f=1MHz)

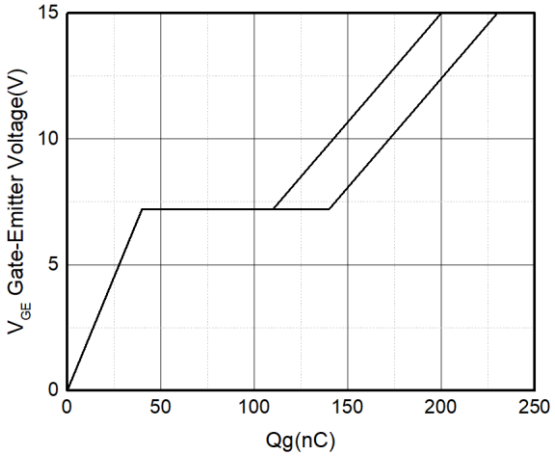


Figure 4. Typical gate charge (IC=50A)

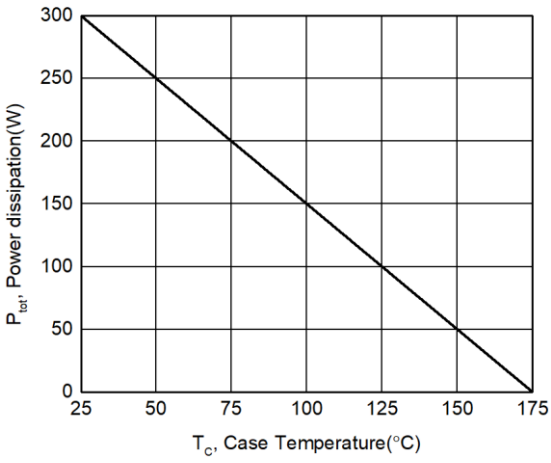


Figure 5. Power dissipation as a function of case temperature (TJ≤175° C)

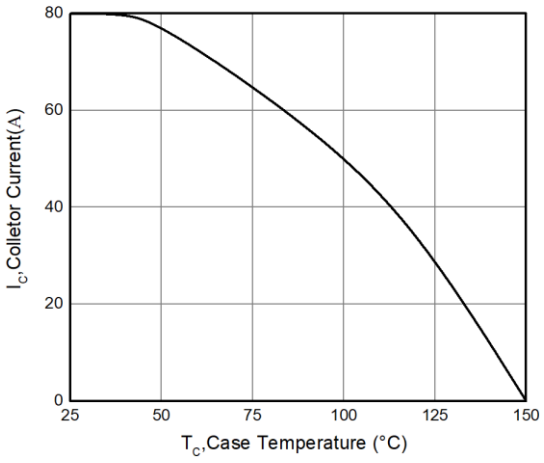


Figure 6. Collector current as a function of case temperature(V_{GE}≥15V, T_j≤150° C)

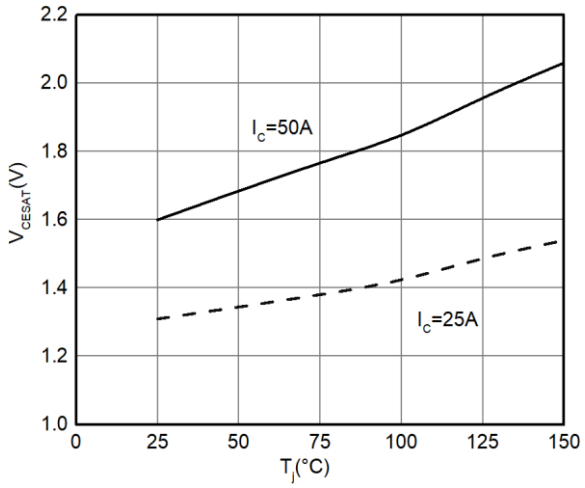


Figure 7. V_{CESAT} as a function of junction temperature (V_{GE}=15V)

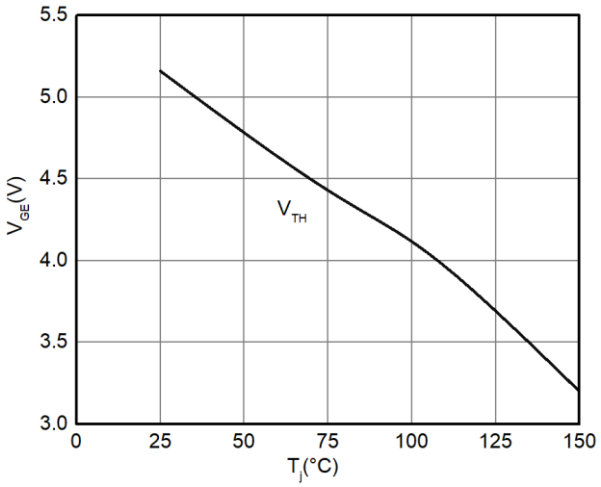


Figure 8. V_{TH} as a function of junction temperature (*I_{CE}=250uA*)

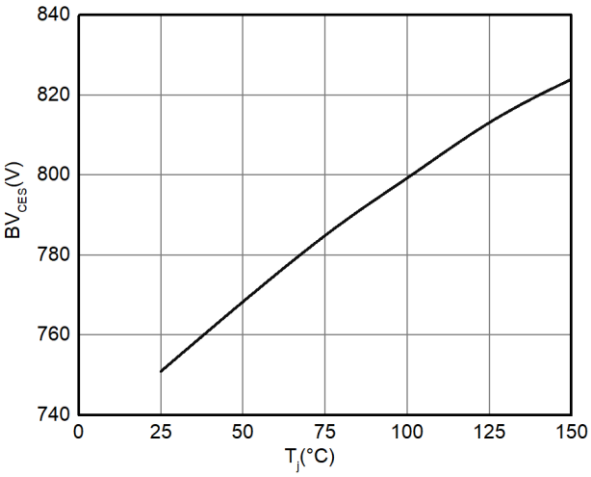


Figure 9. BV as a function of junction temperature (*I_{CE}=250uA*)

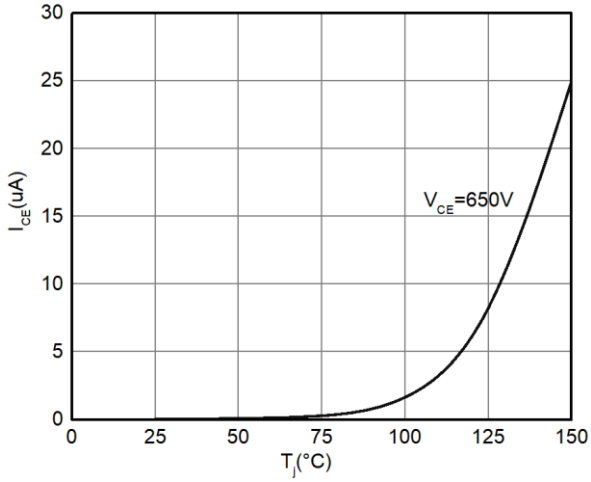


Figure 10. I_{CES} leakage current as a function of junction temperature

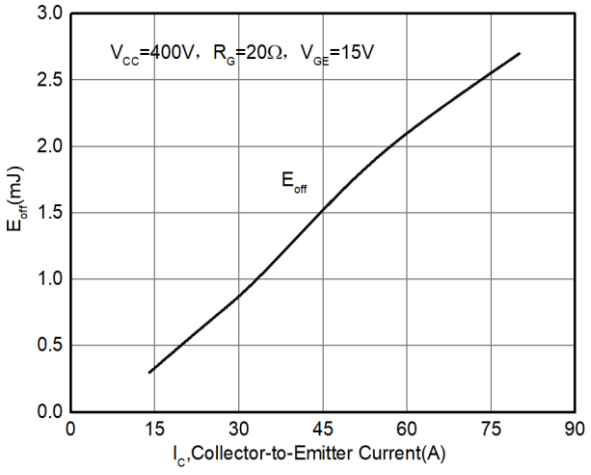


Figure 11. E_{off} as a function of IC (*T_j*=25° C)

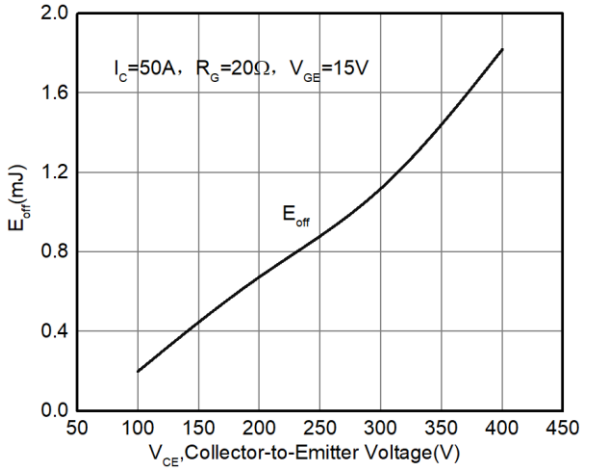


Figure 12. E_{off} as a function of V_{CE} (*T_j*=25° C)

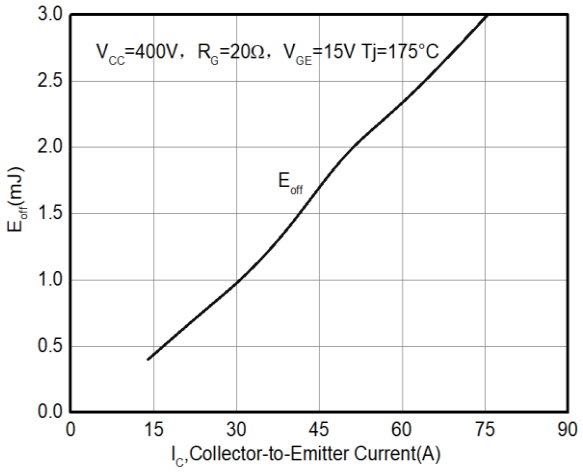


Figure 13. E_{off} as a function of IC (T_j=175° C)

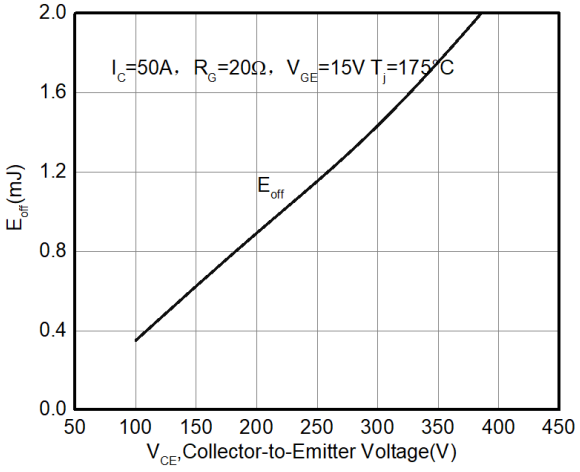


Figure 14. E_{off} as a function of V_{CE} (T_j=175° C)

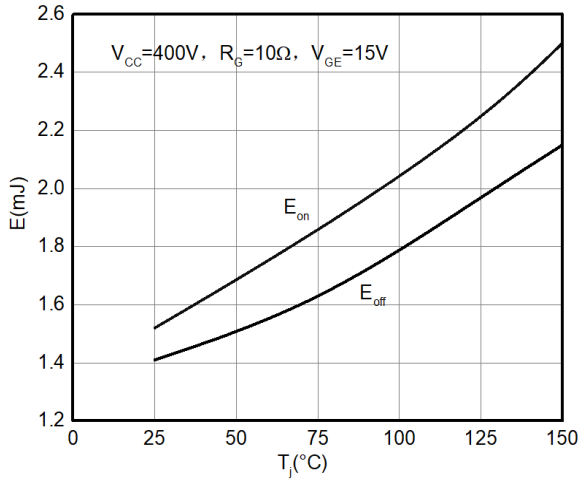


Figure 15. E_{on}&E_{off} as a function of junction temperature

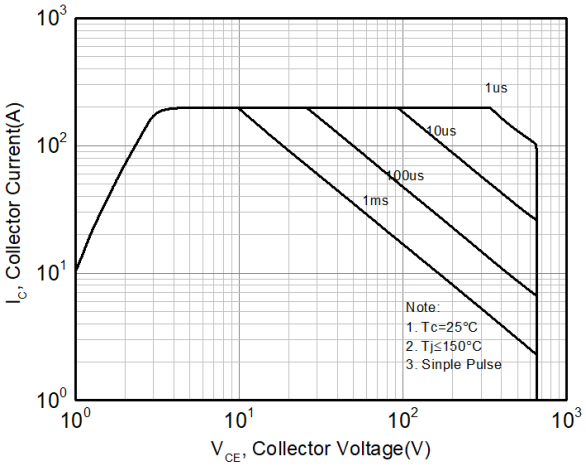


Figure 16. FBSOA

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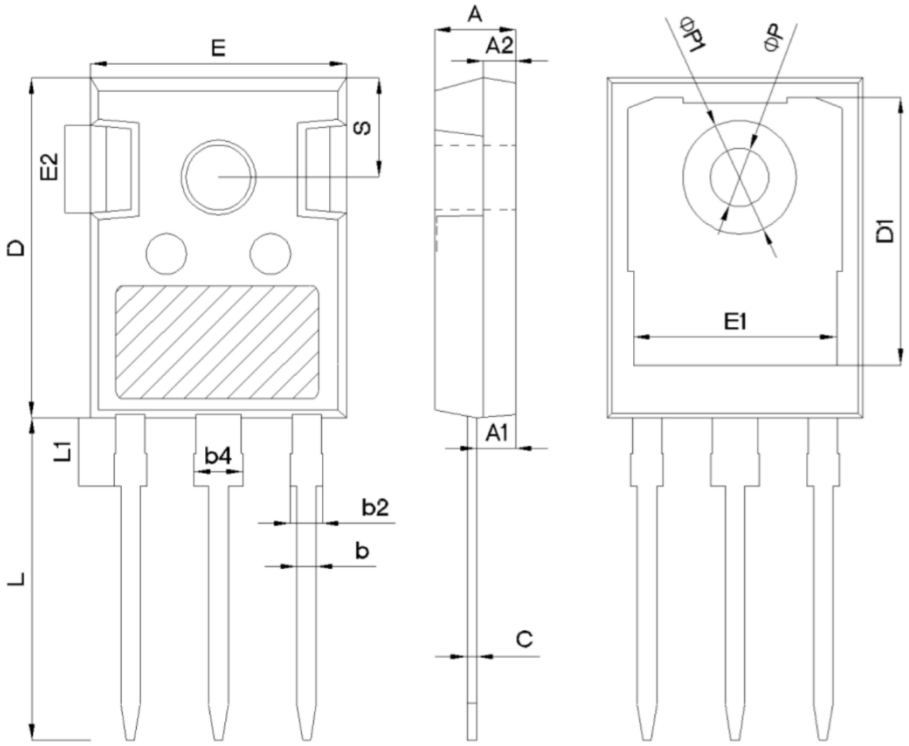

SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		

Revision: 2020-12-27, Rev. 1.0

Revision	Date	Subjects (major changes since last revision)
1.0	2020-12-27	

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